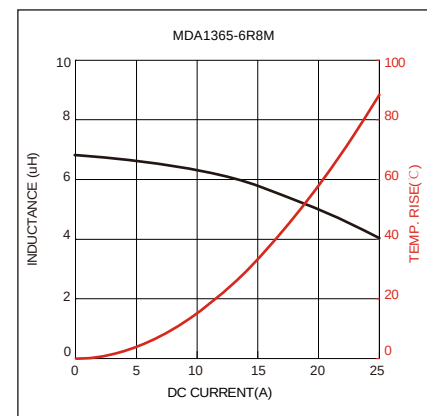
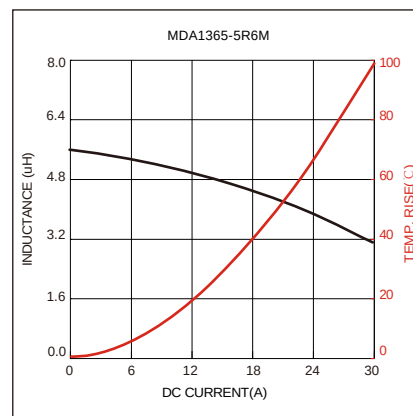
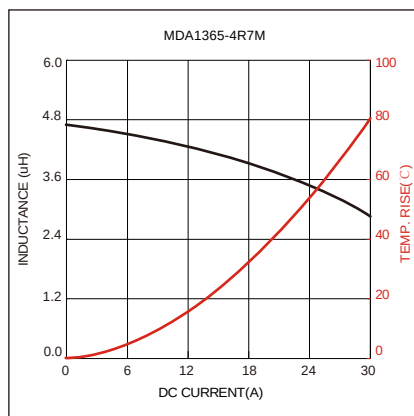
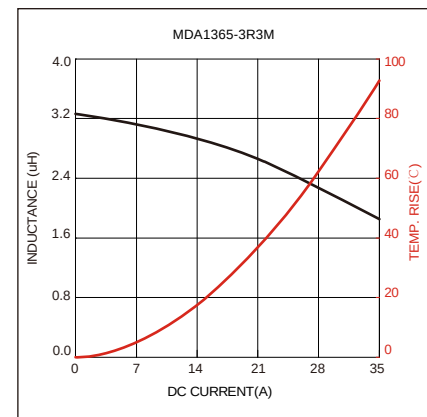
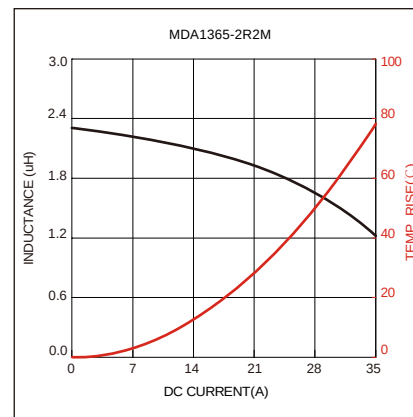
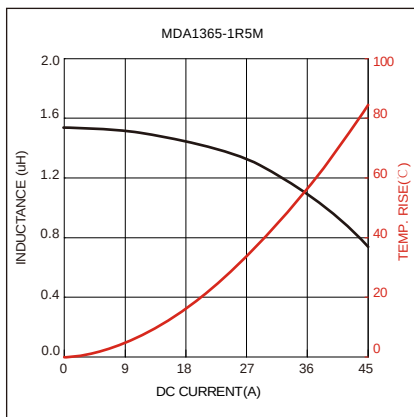
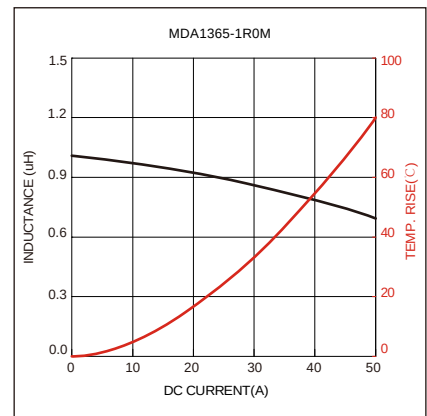
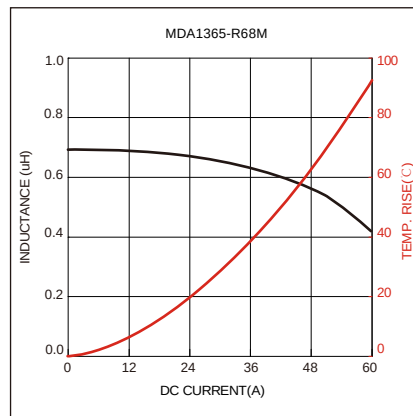
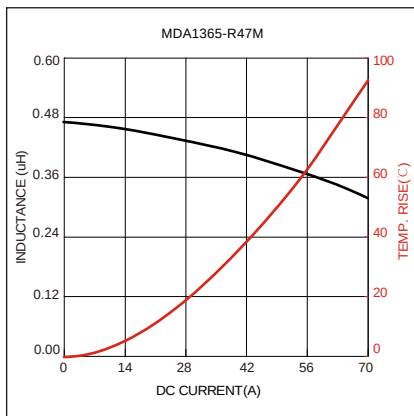


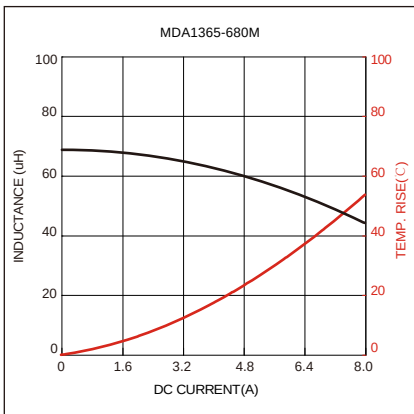
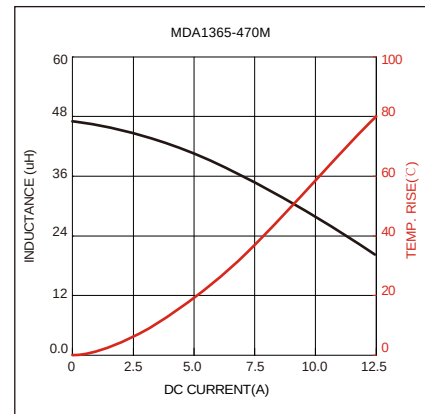
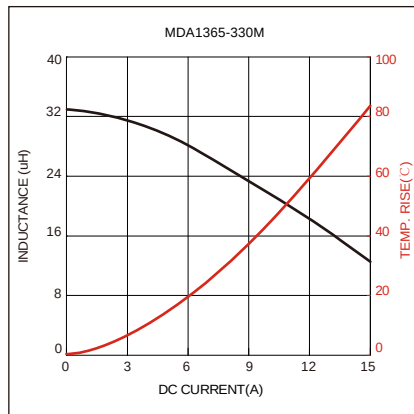
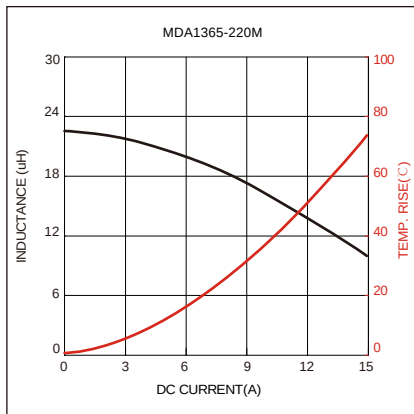
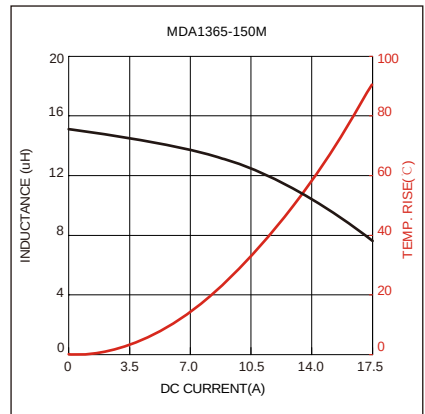
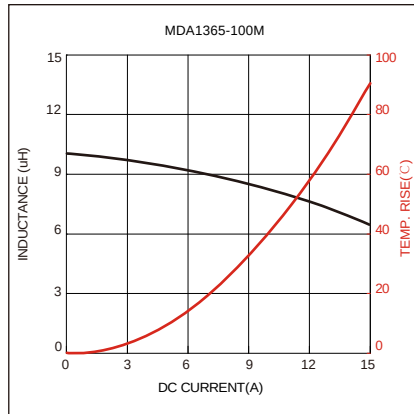
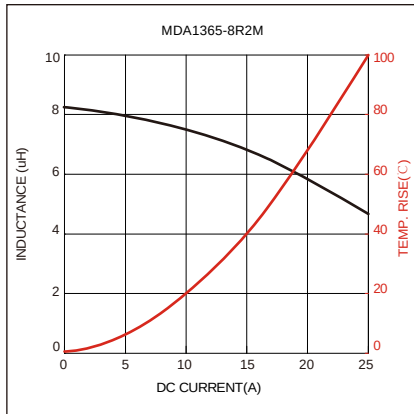
Part No	Inductance @ 100KHz/1V	Tolerance	Temperature Rise Current Typ. (A)	Temperature Rise Current Max. (A)	Current Typ. (A)	Current Max. (A)	DC Resistance Typ.	DC Resistance Max.	E

Saturation Current will cause L to drop approximately 30%

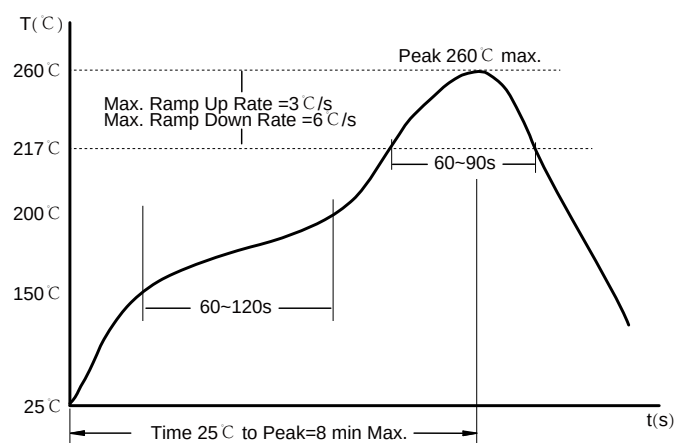
Temperature Rise Current: The actual value of DC current when the temperature rise is $\Delta T=40^{\circ}\text{C}$

Typical Electrical Characteristics:





Soldering Reflow:

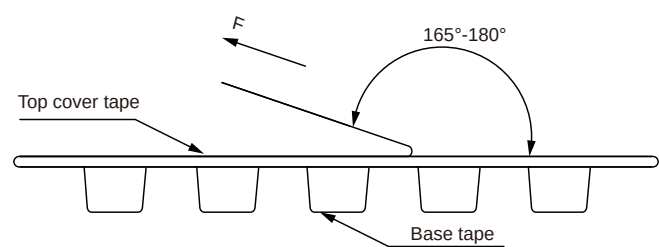


Preheat condition: 150 ~200℃ / 60~120 sec.
Allowed time above 217℃ : 60~90 sec.
Max temperature: 260℃ .
Allowed Reflow time: 2x max.

Packaging Information:

Tape Dimension :

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 1.3 N

Product Marking:

Marking	KH+Printing (Inductance+period)
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